

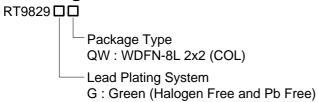
Dual Push-Button Reset with Push-Button Controlled Output Delay

General Description

The RT9829 has two combined delayed reset inputs (SRO, SR1) with a user selectable delayed setup time (t_{SRC}) option of either 7.5s or 12.5s (typ.), selectable via the dual-state DSR input pin. When DSR is connected to ground, $t_{SRC} = 7.5s$ (typ.); when connected to V_{CC} , t_{SRC} = 12.5s (typ.). There are two reset outputs which become active simultaneously after both of the reset inputs are held active for the selected t_{SRC} delay time. The outputs remain asserted until either or both inputs go to inactive logic level (for this device the output reset pulse duration is fully push-button controlled, meaning neither fixed nor minimum reset pulse width, nor power on reset pulse is implemented). The first reset output, RST1, is active low. open drain; the second reset output, RST2, is active high, push-pull. The device fully operates over a broad V_{CC} range from 1.65V to 5.5V. Below 1.575V (typ.), the inputs are ignored and the outputs are de-asserted. The de-asserted reset output levels are then valid down to 1V.

The RT9829 is available in a tiny WDFN-8L 2x2 (COL) package.

Ordering Information



Note:

Richtek products are:

- RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

Marking Information



56 : Product Code W : Date Code

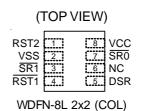
Features

- Dual Reset Push-Button Inputs
 - ▶ User Selectable Delay Setup Time: 7.5s and 12.5s (tvp.)
- Push-Button Controlled Reset Pulse Duration
 - No Fixed nor Minimum Pulse Width Guaranteed
- No Power On Reset
- Dual Reset Outputs
- RST1 : Active Low, Open-Drain
- → RST2 : Active High, Push-Pull
- Fixed Reset Input Logic Voltage Levels
- Broad Operating Voltage Range : 1.65V to 5.5V
 Inactive Reset Output Levels Valid Down to 1V
- 2μA Low Supply Current
- Operating Temperature : -40°C to 85°C
- Small Thermally Enhanced 8-Lead WDFN Package
- RoHS Compliant and Halogen Free

Applications

- Mobile phones, Smartphones
- e-Books
- MP3 Players
- Games
- Portable Navigation Devices

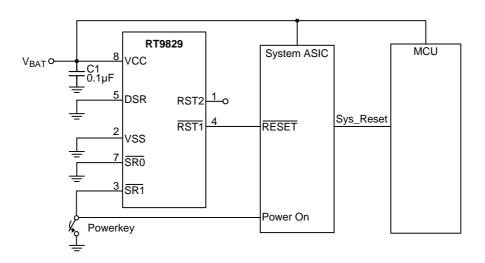
Pin Configurations



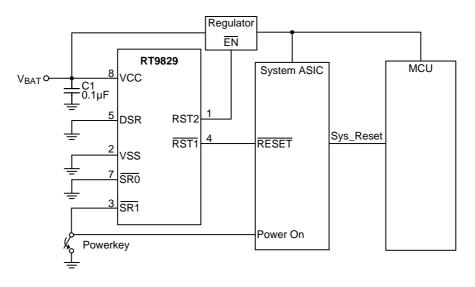


Typical Application Circuit

Typical Operation:



Operation with Regulator:





Timing Diagrams

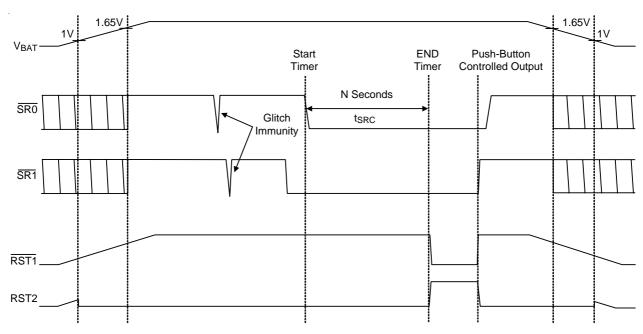


Figure 1. Timing Diagram

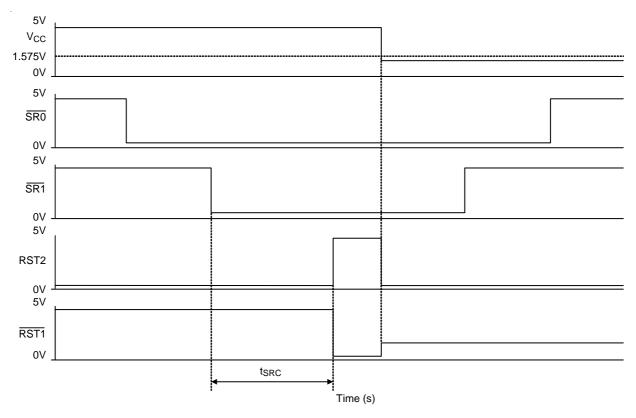


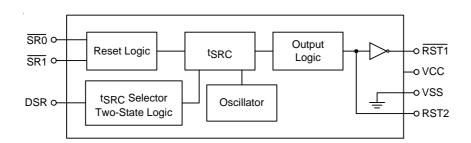
Figure 2. Under Voltage Condition



Functional Pin Description

Pin No.	Pin Name	Pin Function
1	RST2	Second Reset Output (Active High, Push-Pull).
2	VSS	Ground.
3	SR1	Secondary Push-Button Reset Input (Active Low).
4	RST1	First Reset Output (Active Low, Open-Drain).
5	DSR	Dual-State Reset Input Delay Selection Pin. When connected to ground, $t_{SRC} = 7.5s$ (typ.); when connected to VCC, $t_{SRC} = 12.5s$ (typ.). DSR is a DC-type input, intended to be either permanently grounded or permanently connected to VCC.
6	NC	No Internal Connection. Not bonded and should be connected to VSS.
7	SR0	Primary Push-Button Reset Input (Active Low).
8	VCC	Positive Supply Input. A $0.1\mu F$ decoupling ceramic capacitor is recommended to be connected between VCC and VSS pins.

Function Block Diagram





Absolute Maximum Ratings (Note 1)

• Supply Input Voltage, V _{CC} to V _{SS}	0.3V to 6V
Other Pins to V _{SS}	0.3V to 6V
 Power Dissipation, P_D @ T_A = 25°C 	
WDFN-8L 2x2 (COL)	- 0.606W
Package Thermal Resistance (Note 2)	
WDFN-8L 2x2 (COL), θ_{JA}	- 165°C/W
• Junction Temperature	- 150°C
• Lead Temperature (Soldering, 10 sec.)	- 260°C
Storage Temperature Range	- −65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Mode)	- 2kV
MM (Machine Mode)	- 200V
Recommended Operating Conditions (Note 4)	
• Supply Input Voltage, V _{CC} (Note 5)	- 1.65V to 5.5V

Electrical Characteristics

(V_{CC} = 3.3V, T_A = 25°C, unless otherwise specified)

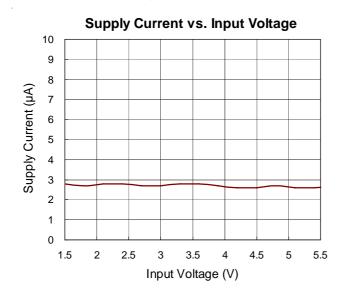
Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit		
Input Power Supply									
Supply Current	Supply Current I _{CC} V _{CC} = 5V			2	3	μΑ			
			$V_{CC} \ge 4.5V$, $I_{SINK} = 3.2mA$			0.3			
Reset Output Voltage Low		V _{OL}	$V_{CC} \ge 3.3V$, $I_{SINK} = 2.5mA$			0.3	V		
			$V_{CC} \ge 1.65V$, $I_{SINK} = 1mA$			0.3			
Reset Output Voltage High, RST2		V _{OH}	$V_{CC} \ge 4.5V$, $I_{SOURCE} = 0.8mA$	0.8 x V _{CC}			V		
			$V_{CC} \ge 2.7V$, $I_{SOURCE} = 0.5mA$	0.8 x V _{CC}					
			$V_{CC} \ge 1.65V$, $I_{SOURCE} = 0.25mA$	0.8 x V _{CC}					
Output Leakage Current, RST1		I _{LO}	Open-Drain, V _{RST1} = 5.5V			0.1	μΑ		
Reset		•							
Reset Delay		t _{SRC}	DSR = VSS	6	7.5	9	s		
			DSR = VCC	10	12.5	15			
SR0, SR1 Input	Logic-Low	V _{IL}		V _{SS} – 0.3		0.3	V		
Threshold Voltage	Logic-High	V _{IH}		1.1		5.5	V		
Input Leakage Current (SR0, SR1, DSR Pins)		ILI		-1		1	μΑ		

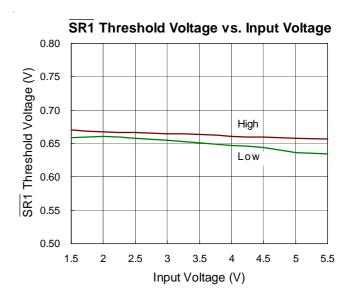


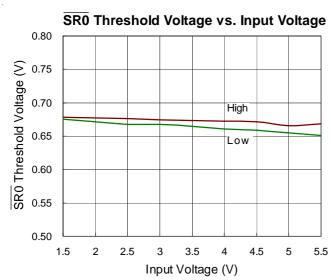
- **Note 1.** Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.
- Note 2. θ_{JA} is measured in natural convection at $T_A = 25$ °C on a high effective thermal conductivity four-layer test board of JEDEC 51-7 thermal measurement standard.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.
- Note 5. Reset outputs are de-asserted below 1.575V (typ.) and remain de-asserted down to $V_{CC} = 1V$.

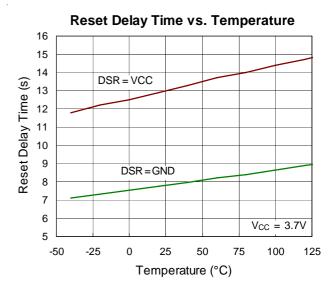


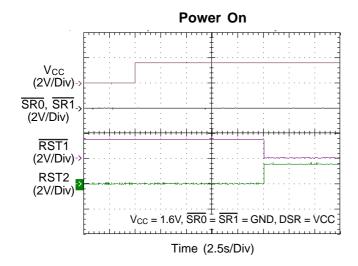
Typical Operating Characteristics

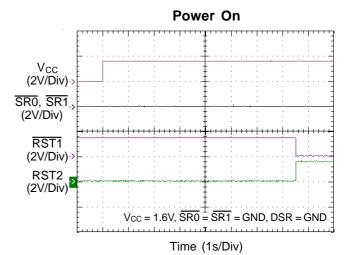








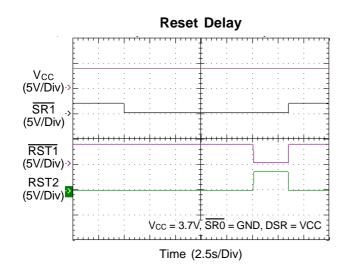


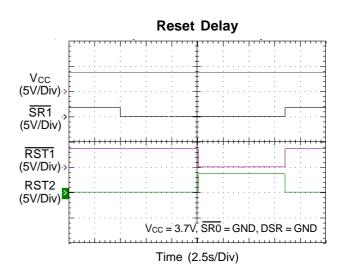


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7

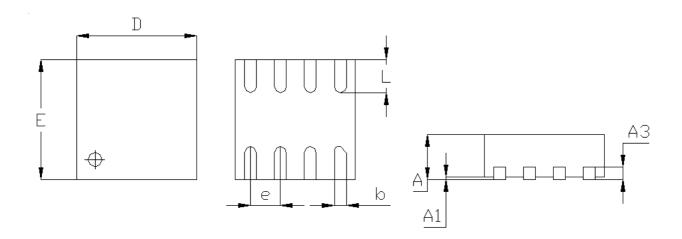








Outline Dimension



O. mark all	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A3	0.175	0.250	0.007	0.010	
b	0.150	0.250	0.006	0.010	
D	1.900	2.100	0.075	0.083	
Е	1.900	2.100	0.075	0.083	
е	0.500		0.020		
L	0.500	0.600	0.020	0.024	

W-Type 8L DFN 2x2 (COL) Package

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